

RD151TS502US

PLL clock generator series

REJ03D0898-0100

Rev.1.00

Apr 25, 2007

Description

RD151TS502US is phase-locked loop clock generator with high-performance. And RD151TS502US is low-jitters and will enable high density mounting by shrink small-size package (SSOP-8).

Features

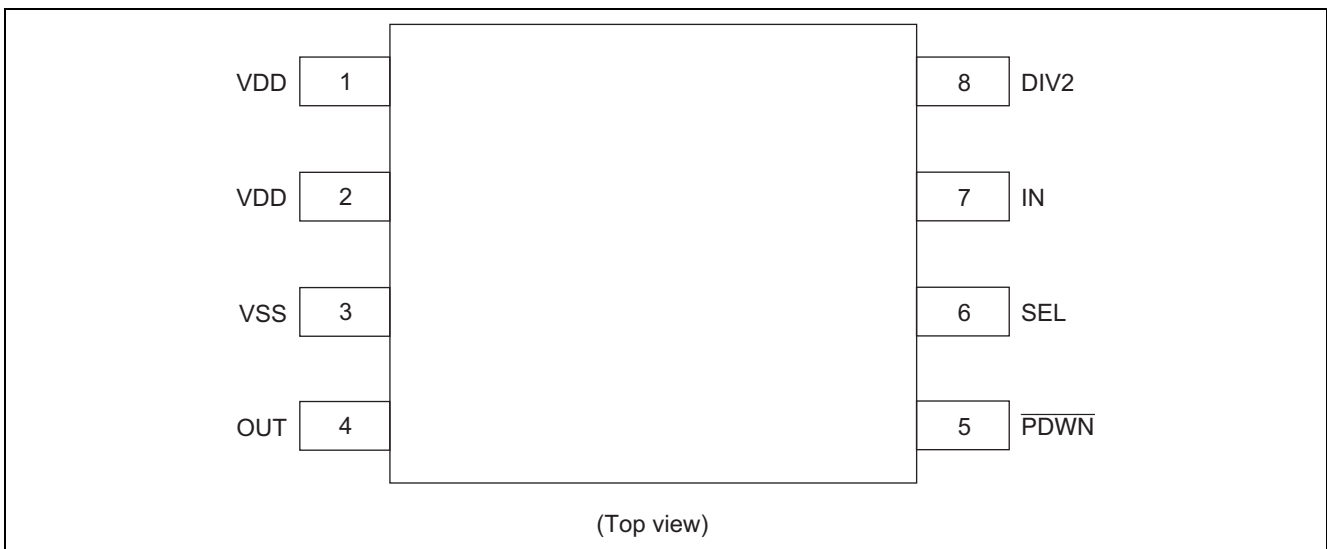
- Input frequency: 27.0 MHz
- Output frequency: 27.0 MHz (1 : 1), 33.75 MHz (1 : 1.25)
13.5 MHz (1 : 0.5), 16.875MHz (1 : 0.625) (Selectable)

Key Specifications

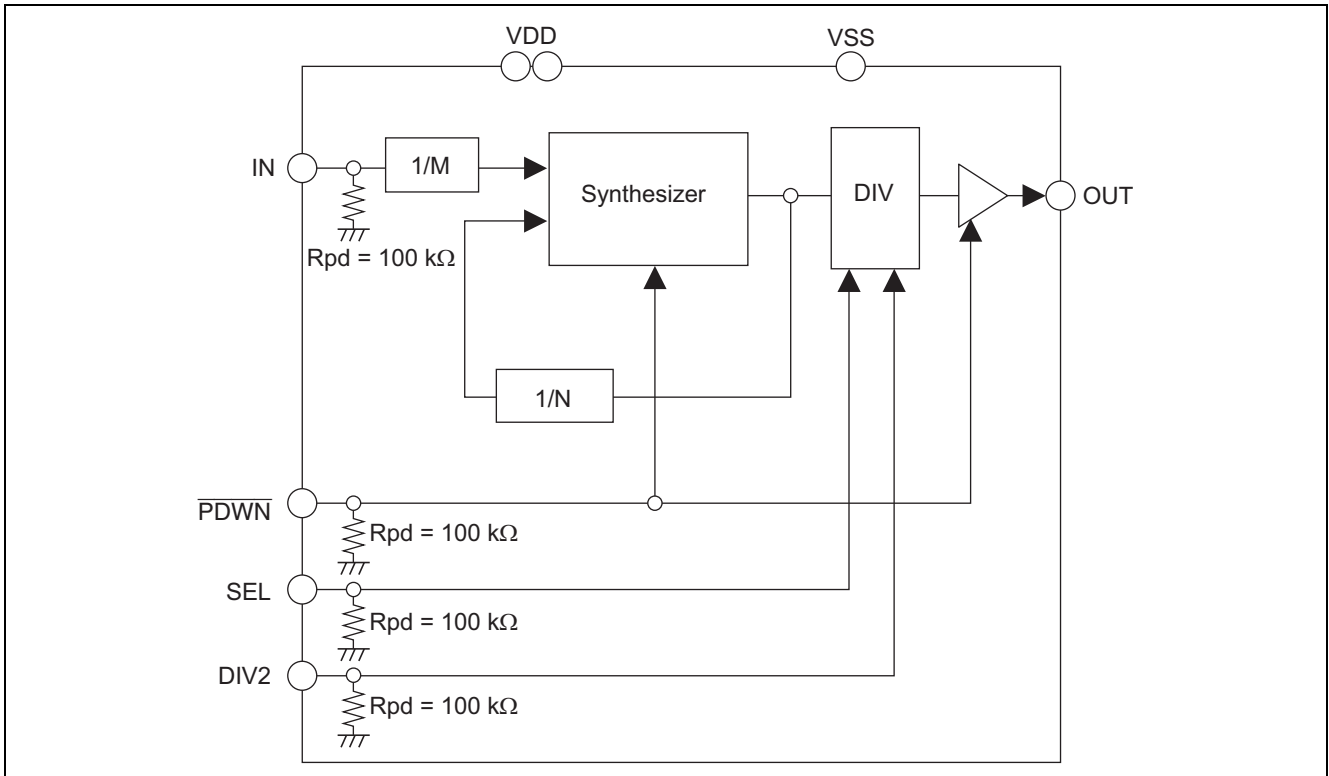
- Supply voltages: $V_{DD} = 2.7$ to 3.6 V
- Operating temperature = -10 to 75 °C
- Cycle to cycle jitter = ± 75 ps typ.
- Clock output duty cycle = $50 \pm 5\%$
- Stabilization time: 2ms max
- Power-down mode is supported
- Ordering Information

Part Name	Package Type	Package Code (Previous Package Code)	Package Abbreviation	Taping Abbreviation (Quantity)
RD151TS502USE	SSOP-8 pin	PVSP0008KA-A (TTP-8DBV)	US	E (3,000 pcs / Reel)

Pin Arrangement



Block Diagram



Pin Descriptions

Pin name	No.	Type	Description
VDD	1,2	Power	Power supply
VSS	3	Ground	GND
OUT	4	Output	Clock signal output
$\overline{\text{PDWN}}$	5	Input	Power-down control * ¹
SEL	6	Input	Frequency select * ¹
IN	7	Input	Clock signal input * ¹
DIV2	8	Input	Frequency select * ¹

Note: 1. LVCMOS level input. Pull-down by internal resistor (100 kΩ).

Power-down Function Table

$\overline{\text{PDWN}}$	IC Operating	OUTPUT	Remark
L	Power-down	Low level	Default * ¹
H	Active	Clock signal output	

Note: 1. All Circuits are set stand-by condition.

Clock Frequency Table

SEL	DIV2	Output Frequency (IN:OUT Ratio)	Remark
L	L	27.0 MHz (1:1)	Default
H	L	33.75 MHz (1:1.25)	
L	H	13.5 MHz (1:0.5)	
H	H	16.875 MHz (1:0.625)	

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{DD}	-0.5 to 4.6	V	
Input voltage	V_I	-0.5 to 4.6	V	
Output voltage	V_O	-0.5 to $V_{DD}+0.5$	V	
Input clamp current *1	I_{IK}	-50	mA	$V_I < 0$
Output clamp current *1	I_{OK}	-50	mA	$V_O < 0$
Continuous output current	I_O	± 50	mA	$V_O = 0$ to V_{DD}
Maximum power dissipation	P_W	0.2	W	$T_a = 25^\circ\text{C}$ (in still air)
Storage temperature	T_{stg}	-65 to +150	$^\circ\text{C}$	

Notes: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

- The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

Recommended Operating Conditions

Item	Symbol	Min	Typ	Max	Unit	Conditions
Supply voltage	V_{DD}	2.7	3.3	3.6	V	
DC input signal voltage		-0.3	—	$V_{DD}+0.3$	V	
Operating temperature	T_a	-10	—	75	$^\circ\text{C}$	

DC Electrical Characteristics

$T_a = -10$ to 75°C , $V_{DD} = 2.7$ to 3.6 V

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Input voltage	V_{IL}	—	—	0.8	V	IN, PDWN, SEL, DIV2 pins
	V_{IH}	2.0	—	—	V	IN, $\overline{\text{PDWN}}$, SEL, DIV2 pins
Input current	I_I	—	—	± 100	μA	$V_I = 0\text{V}$ or 3.6V , IN, $\overline{\text{PDWN}}$, SEL, DIV2 pins
Input capacitance	C_I	—	3	—	pF	IN, PDWN, SEL, DIV2 pins
Output voltage	V_{OL}	—	—	0.5	V	$V_{OL} = 1$ mA, $V_{DD} = 3.3$ V, OUT pin
	V_{OH}	$V_{DD}-0.2$	—	V_{DD}		$V_{OH} = -1$ mA, $V_{DD} = 3.3$ V, OUT pin
Output current	I_{OL}	—	15	—	mA	$V_{OL} = 1.65$ V, $V_{DD} = 3.3$ V, OUT pin
	I_{OH}	—	-15	—	mA	$V_{OH} = 1.65$ V, $V_{DD} = 3.3$ V, OUT pin
Output impedance		—	30	—	Ω	OUT pin
Pull-down resistor	R_{pd}	80 k	100 k	120 k	Ω	

Note: The condition of the minimum and maximum value must use the value specified under "Recommended Operating Conditions".

Parameters are target of design. Not 100% tested in production.

AC Electrical Characteristics

$T_a = -10$ to 75 °C, $V_{DD} = 2.7$ to 3.3 V, $C_L = 15$ pF

Item	Symbol	Min	Typ	Max	Unit	Test Conditions	Notes
Operating current	I_{DD}	—	6	—	mA	$V_{DD} = 3.3$ V, $\overline{PDWN} = 1$, $C_L = 0$ pF	
Stand-by current	I_{DDPD}	—	10	—	μA	$V_{DD} = 3.3$ V, $\overline{PDWN} = 0$, $I_N = 0$ V	
Cycle to cycle jitter	t_{CCJ}	—	75	—	ps	$C_L = 0$ pF	Figure 1
Output Frequency		—	13.5	—	MHz	SEL = 0, DIV2 = 1	*1 Figure 2
		—	16.875	—		SEL = 1, DIV2 = 1	
		—	27.0	—		SEL = 0, DIV2 = 0	
		—	33.75	—		SEL = 1, DIV2 = 0	
Frequency accuracy		-50	—	50	ppm		*2
Slew Rate	t_{SR}	—	1.5	—	ns	$V_{DD} = 3.3$ V, $0.2V_{DD}$ to $0.8V_{DD}$	
Clock duty cycle	t_{DT}	45	50	55	%		
Stabilization time	t_{SB}	—	—	2	ms		*3

Notes: Parameters are target of design. Not 100% tested in production.

1. Output Frequency means average value.
2. The accuracy of the output frequency to a set value.
3. Stabilization time is the time required for the integrated circuit to obtain phase lock of its input signal after power up.

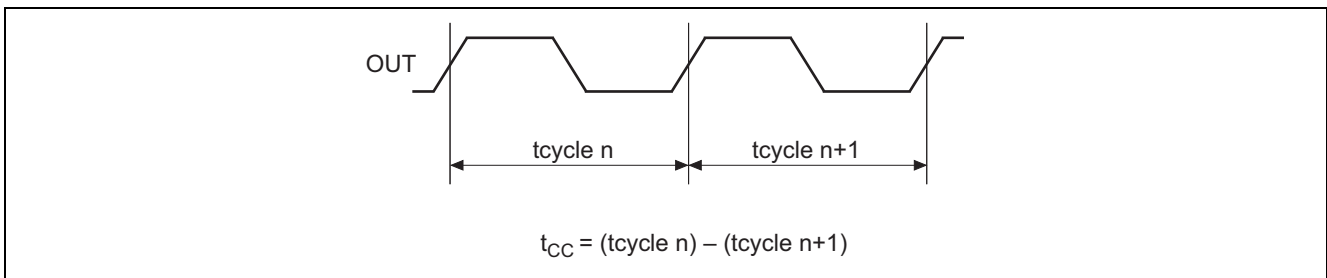


Figure 1 Cycle to cycle jitter

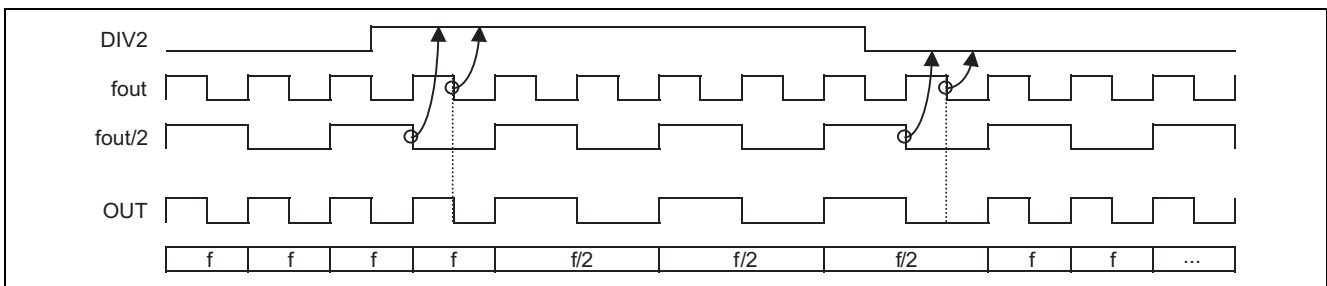


Figure 2 Timing chart

Recommended Circuit Configuration

The power supply circuit of the optimal performance on the application of a system should refer to Figure 3.

V_{DD} decoupling is important to reduce Jitter performance.

The C1 decoupling capacitor should be placed as close to the VDD pin as possible, otherwise the increased trace inductance will negate its decoupling capability.

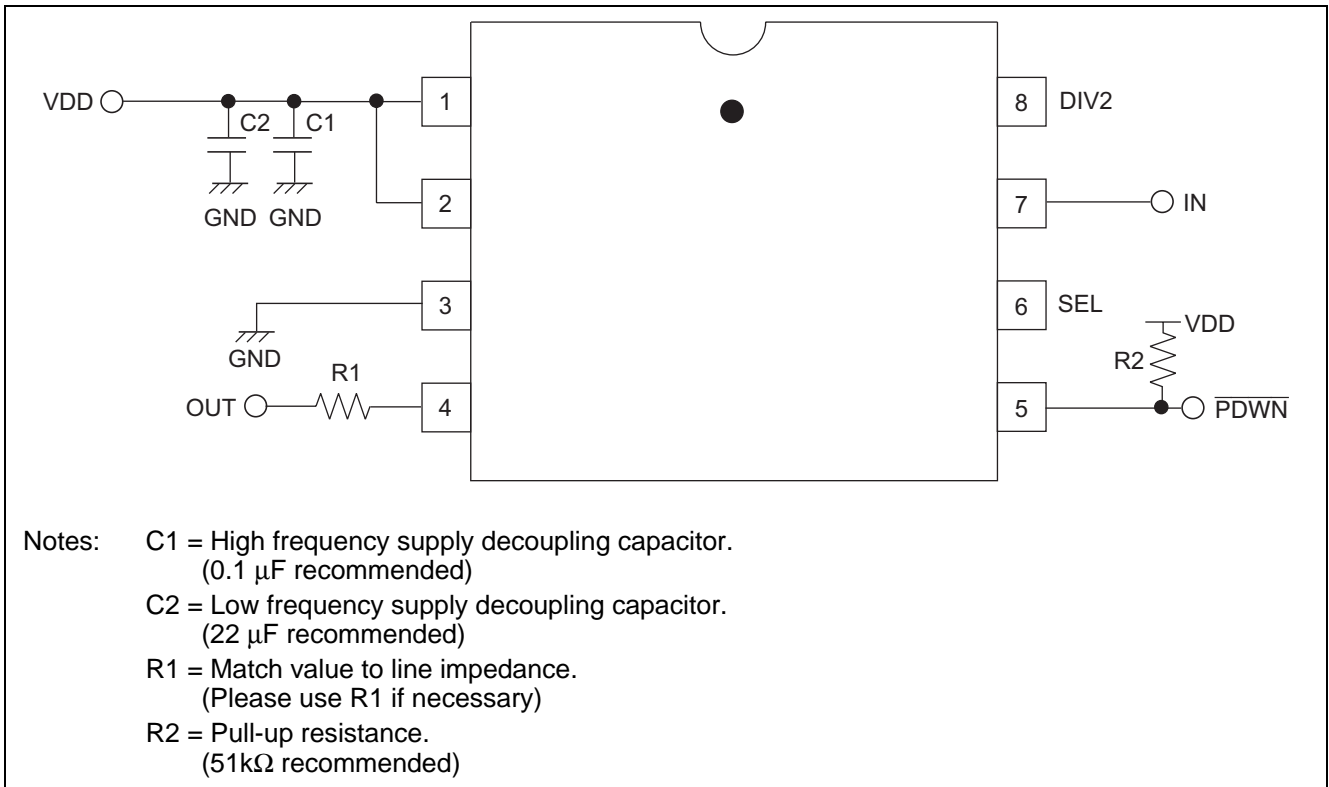


Figure 3 Recommended circuit configuration

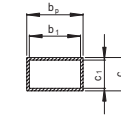
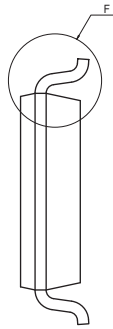
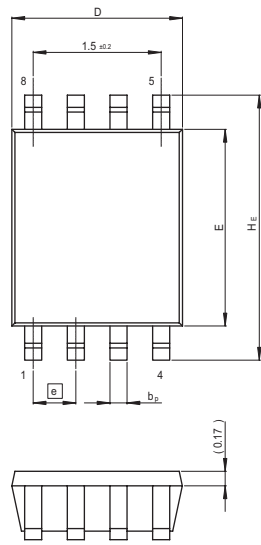
Remark for use

- Please do not use the pull-up resistance for the OUT terminal to prevent wrong operation of IC.
- Please set the voltage of the PDWN terminal according to the following procedures when it is necessary to set IC to power-down (standby) operation immediately after the start-up this IC.
 1. Set the Hi level voltage when IC starts.
 2. Set the Low level voltage after IC starts.

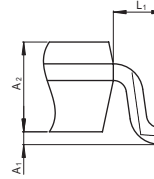
As this counter measures, we recommend the pull-up register that has been described to the above recommended circuit to be added beforehand.

Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-VSSOP8-2.3x2-0.50	PVSP0008KA-A	TTP-8DB/TTP-8DBV	0.010g



Terminal cross section



Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	1.8	2.0	2.2
E	2.2	2.3	2.4
A ₂	0.6	0.7	0.8
A ₁	0	—	0.1
A	—	—	—
b _p	0.15	0.22	0.3
b ₁	—	0.20	—
c	0.08	0.13	0.23
c ₁	—	0.11	—
θ	—	—	—
H _E	2.8	3.1	3.4
ⓐ	—	(0.5)	—
x	—	—	—
y	—	—	—
Z	—	—	—
L	—	—	—
L ₁	—	(0.4)	—

Notes:

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